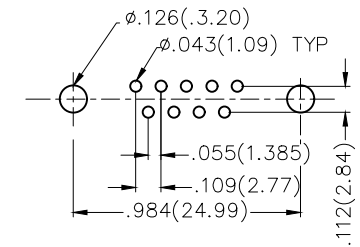
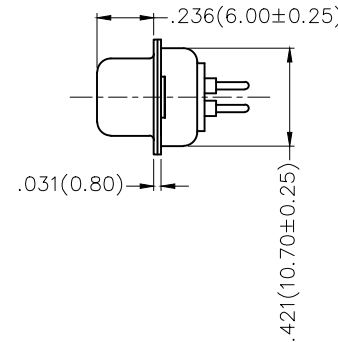
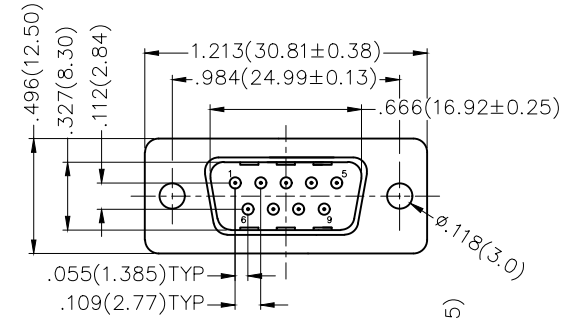
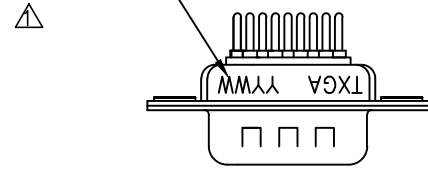
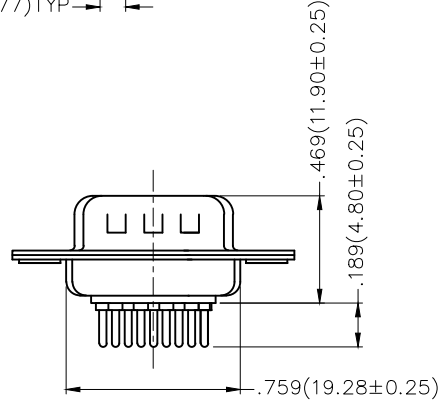


REV	LOCATIONS	DESCRIPTION	DATE	REVSER	APPD
1	△	Add marking code	13/Jan/25	NICK	LEO

Date Code



Recommended P.C.Board Layout



Ordering Information

FDM 09 05 — MO D S 1 XX XX X
 1 2 3 4 5 6 7 8 9 10


1 Category	2 Circuits	3 Distinction No.	4 Type	5 Assembly Layout
FDM—Machined pin D—SUB connector	09	05	MO—Male	D—DIP
6 Entry Angle	7 Plating	8 Thickness of Plating	9 Color—Resin	10 Packaging
S—180° Vertical	1—Gold Plated	01—1μ" 03—3μ" Custom plate available	W1—White K6—Black	K—Tray L—Tube

Materials And Finish

Shell: Spcc Material, Front Nickel Plated 80μ" Min
 Back Shell: SPCC, Tin Plated 100μ" Min
 Insulator: Glass Filled Thermoplastic, UL 94V-0
 Contact Material: Brass /Gold Plated

Electrical Characteristic

Current Rating: 7.5A
 Voltage Rating: 300V
 Contact Resistance: 5mΩ Max
 Dielectric Withstanding Voltage :1000V AC r.m.s
 Insulation Resistance: 5000 MΩ Min.
 Temperature Range—Operating: -55°C ~ +105°C

THIRD ANGLE PROJECTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		APPROVE BY	DATE	PART NO.	ITEM NO.	 Leader Of Industry
	X.±.012(0.30)	X.±5'	FRANK	23/JUL/13	FDM0905—MODS1XXXXX	FDM0905	
DESIGN UNITS Inch (metric)	X.X±.008(0.20)	.X'±2'	CHECKED BY	DATE	TITLE		REV 1
SCALE	X.XX±.006(0.15)	.XX'±1'	CHERRY	23/JUL/13	Machined pin D—SUB connector 180° Vertical Male		SHEET NO. 1/1
SIZE 5:1	X.XXX±.004(0.10)	.XXX'±0.5'	DRAWN BY	DATE	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO TXGA INDUSTRIAL ELECTRONICS(S.Z)CO.,LTD AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		
A4			JACOB	23/JUL/13			